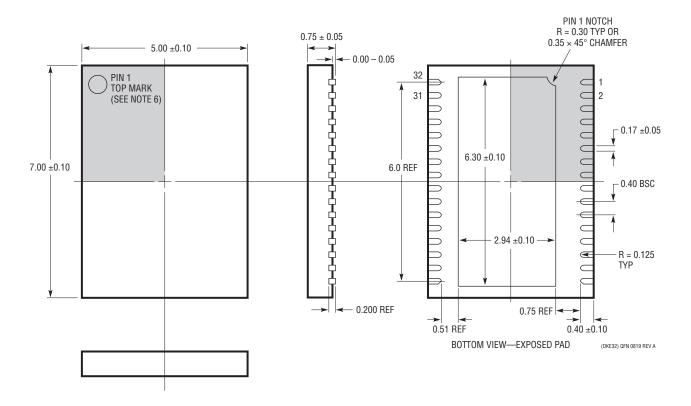


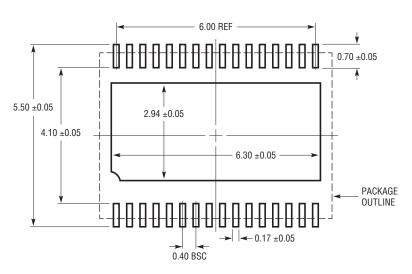
$\begin{array}{c} \textbf{DKE Package} \\ \textbf{32-Lead Plastic DFN (7mm} \times 5mm) \end{array}$

(Reference LTC DWG # 05-08-1789 Rev A)



NOTE

- DRAWING CONFORMS TO JEDEC PACKAGE
 OUTLINE MO-220 VARIATION WHKD
- 2. DRAWING NOT TO SCALE
- 3. ALL DIMENSIONS ARE IN MILLIMETERS
- 4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.20mm ON ANY SIDE
- 5. EXPOSED PAD SHALL BE SOLDER PLATED
- 6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE



RECOMMENDED SOLDER PAD LAYOUT APPLY SOLDER MASK TO AREAS THAT ARE NOT SOLDERED